ASSIGNMENT RECORDATION FORM COVER SUFER 11-14-2005 To: Commissioner for Patents: Date: November 4, 2005 Attorney Docket No. 5649-1655 103118097 Please record the attached original documents or c 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): Jung-Bae Lee Samsung Electronics, Co. Ltd. 416 Maetan-dong, Yeongtong-gu Suwon-si, Gyeonggi-do Republic of Korea Additional name(s) of conveying party(ies) attached? _ 3. Nature of conveyance: X Assignment _ Merger Security Agreement Change of Name Other Execution Date: October 21, 2005 Additional name(s) & address(es) attached? 4. Application Serial No. _____Patent No. ____ If this document is being filed together with a new application, the execution date of the application is: October 21, 2005 Additional numbers attached? Yes 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: 7. Total fee (37 CFR 3.41) \$40.00 X Enclosed Robert M. Meeks Authorized to be charged to deposit account Myers Bigel Sibley & Sajovec P. O. Box 37428 Raleigh NC 27627 8. Deposit account number: 50-0220 DO NOT USE THIS SPACE 9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. November 4, 2005 Robert M. Meeks #40,723 Date Name of Person Signing Total number of pages including cover sheet, attachments and document: 3 CERTIFICATE OF EXPRESS MAILING

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I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR § 1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-

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ASSIGNMENT

THIS ASSIGNMENT, made by me, **Jung-Bae Lee**, citizen of the Republic of Korea, residing at #523-302, Samsung 5th Apt., Jinsan Maeul, Pungdeokcheon-ri, Suji-eup, Yongin-si, Gyeonggi-do, Republic of Korea

WITNESSETH: That,

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made.

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ASSIGNMENT - CONTINUED

I hereby request that said Letters Patent be issued in accordance with this assignment. I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

I further covenant and agree to bind my heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to me relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITN of Oct.	ESS WHEREOF, I have hereunto set r, 2005.	my hand and seal on this 21st da	У
	Jung-Bae Lee	(SEAL)	
Witnessed by:			
Printed Name:			
Date:			

Page 2 of 2

PATENT REEL: 017190 FRAME: 0735

RECORDED: 11/04/2005